

Atty. Docket No. AMAT/6060/CALB/COPPER/PJS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Patent Application Assistant Commissioner of Patents and Trademarks Washington, D.C. 20231

Re:

Inventor(s):

DONALD J.K. OLGADO; AVI TEPMAN; DMITRY LUBOMIRSKY and

TIMOTHY R. WEBB

Title:

SYSTEM FOR PLANARIZING METAL CONDUCTIVE LAYERS

Transmitted herewith is the patent application identified above, including:

- Specification, claims and abstract, totaling 35 pages. <u>X</u>
- Drawings totaling 10 pages, X Formal Informal. X
- Executed Declaration and Power of Attorney. Χ
- Information Disclosure Statement w/ Form 1449 and References.
- Assignment of the invention to Applied Materials, Inc. <u>X</u>

Assignment Recordation Cover Sheet

FEE CALCULATION					
Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total
Total Claims	46	-20=	26	x \$18.00	468.00
Independent Claims	11	-3=	8	x \$84.00	672.00
Basic Filing Fee \$740.00					\$740.00
TOTAL FEES					\$1,880.00

- The Commissioner is hereby authorized to charge \$1,880.00 to Deposit Account No. 50- $\overline{\mathbf{X}}$ 1074/6060/CALB/COPPER/PJS/RWM.
- The Commissioner is hereby authorized to charge any additional fees which may be required, X or credit any overpayment to Deposit Account No. 50-1074/6060/CALB/COPPER/PJS/RWM. A duplicate copy of this transmittal is enclosed.
- Please address all future correspondence to: <u>X</u>

PATENT COUNSEL

APPLIED MATERIALS, INC.

Legal Affairs Department

P.O.BOX 450A

Santa Clara, CA. 95052

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231.

EV041915839US

Robert W. Mulcahy Registration No. 25,436

Respectfully submitted

(713) 623-4844

T:\MPS Forms\forms\Appm\New-Patent\Merge\pto-trn-mrg doc